

# PRM3R9N08N5

# PFC Device Corporation

# 80V Single N-Channel MOSFET

# Major ratings and characteristics

Characteristics	Values	Units
$V_{DS}$	80	٧
$I_{D}^{5} (T_{C}=25^{\circ}C)$	129	Α
Max. R <sub>DS(ON)</sub> @V <sub>GS</sub> =10V	3.9	mΩ
Max. R <sub>DS(ON)</sub> @V <sub>GS</sub> =4.5V	4.2	mΩ
T <sub>J</sub> Operating Junction Temperature	-55 to +150	°C

# **General Description**

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.

# PRM3R9N08N5 DFN 5x6

# **Typical Applications**

- Charger Adapter
- Power Tools
- LED Lighting

### **Features**

- Max. R<sub>DS(ON)</sub>=3.9mΩ@V<sub>GS</sub>=10V
- Improved dv/dt capability
- Fast switching
- 100% E<sub>AS</sub> Guaranteed
- Green Device Available

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# 1. Characteristics

# **Maximum Ratings Characteristics**

( $T_A = 25$  °C unless otherwise specified)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	80	V
$V_{GS}$	Gate-Source Voltage	±20	V
I <sub>D</sub> <sup>5</sup>	Drain Current – Continuous (T <sub>C</sub> =25°C)	129	Α
I <sub>D</sub>	Drain Current – Continuous (T <sub>C</sub> =100°C)	81	Α
$I_D^6$	Drain Current – Continuous (T <sub>C</sub> =25°C)	85	Α
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	340	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>2</sup>	70	mJ
I <sub>AS</sub>	Single Pulse Avalanche Current <sup>2</sup>	37	Α
В	Power Dissipation (T <sub>C</sub> =25°C)	83	W
P <sub>D</sub>	Power Dissipation – Derate above 25°C	0.6	W/°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	°C

### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient		55	°C/W
$R_{ heta JC}$	Thermal Resistance Junction to Case		1.5	°C/W



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### **Electrical Characteristics**

(T<sub>J</sub> = 25 °C unless otherwise specified)

### **Off Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	80			V
	Danier Courses Lorden as Courses	V <sub>DS</sub> =80V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C			1	uA
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =64V, V <sub>GS</sub> =0V, T <sub>J</sub> =100°C			100	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA

### On Characteristics

D	(ON) Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =20A		2.6	3.9	$m\Omega$
$R_{DS(ON)}$	Static Dialii-Source On-Nesistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A		3.4	4.2	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.0	1.6	2.5	<b>V</b>
$g_{fs}$	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =10A	1	52	ł	S

### **Dynamic and switching Characteristics**

	T + 10 + 01 3 4			
$Q_{q}$	Total Gate Charge <sup>3, 4</sup>		 74	
$Q_{qs}$	Gate-Source Charge <sup>3, 4</sup>	$V_{DS}$ =40V, $V_{GS}$ =10V, $I_{D}$ =20A	 14.9	 nC
$Q_gd$	Gate-Drain Charge <sup>3, 4</sup>		 11.3	
$T_{d(on)}$	Turn-On Delay Time <sup>3, 4</sup>		 20	
T <sub>r</sub>	Turn-On Rise Time <sup>3, 4</sup>	$V_{DD}$ =40V, $V_{GS}$ =10V, $R_{G}$ =3 $\Omega$ $I_{D}$ =20A	 81	 no
$T_{d(off)}$	Turn-Off Delay Time <sup>3, 4</sup>		 47	 ns
$T_f$	Turn-Off Fall Time <sup>3, 4</sup>		 14	
C <sub>iss</sub>	Input Capacitance		 4790	
$C_{oss}$	Output Capacitance	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V, f=1MHz	 903	 pF
C <sub>rss</sub>	Reverse Transfer Capacitance		 46	
$R_{g}$	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz	 0.5	 Ω

### **Drain-Source Diode Characteristics**

$V_{SD}^{3}$	Source to Drain Diode Voltage	$V_{GS}=0V$ , $I_{S}=1A$	 	1	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>s</sub> =20A, di/dt=100A/us	 49	1	ns
$Q_{rr}$	Reverse Recovery Charge	1 <sub>S</sub> =20A, ai/al=100A/uS	 66		nC

### Note:

- 1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
- 2. L=0.1mH,  $R_G=25\Omega$ , Starting  $T_J=25^{\circ}C$
- 3. The data tested by pulsed, pulse width  $\leq$ 300us, duty cycle  $\leq$ 2%.
- 4. Essentially independent of operating temperature.
- 5. Silicon limited.
- 6. Package limited.

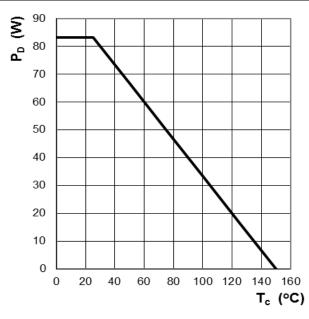


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# 2. Characteristics Curves

# **Ratings and Characteristics Curves**

# ( T<sub>A</sub> = 25° unless otherwise specified )



140 100 100 80 60 40 20 25 50 75 100 125 150 T<sub>c</sub> (°C)

**Figure 1: Power Dissipation** 

Figure 2: Continuous Drain Current vs. T<sub>C</sub>

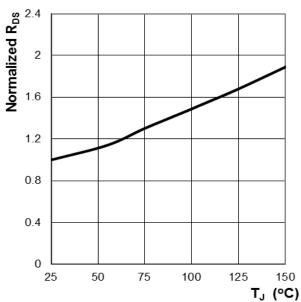


Figure 3: Normalized R<sub>DS(ON)</sub> vs. T<sub>J</sub>

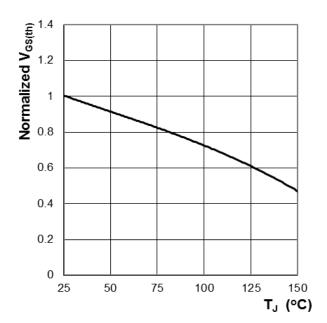


Figure 4: Normalized Vth vs. T<sub>J</sub>



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### **Ratings and Characteristics Curves**

# ( $T_A = 25^{\circ}C$ unless otherwise specified )

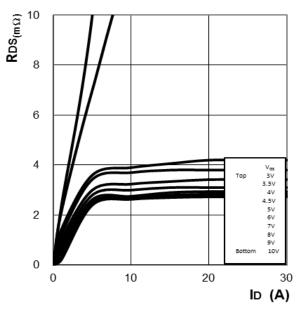


Figure 5: RDS(ON) vs. Drain Current and Gate Voltage

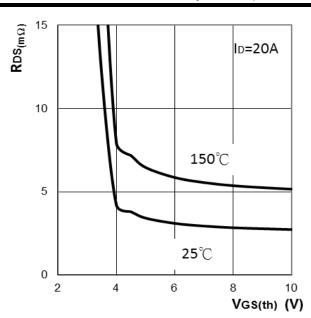


Figure 6: RDS(ON) vs. Gate Voltage

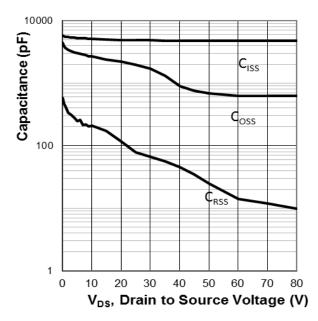


Figure 7: Typ. Capacitance Characteristics

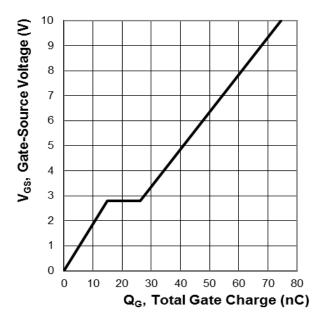


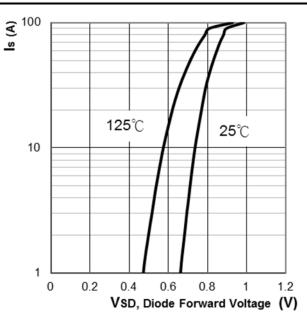
Figure 8: Typ. Gate Charge Characteristics



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### **Ratings and Characteristics Curves**

# ( T<sub>A</sub> = 25° unless otherwise specified )



**Figure 9: Body Diode Characters** 

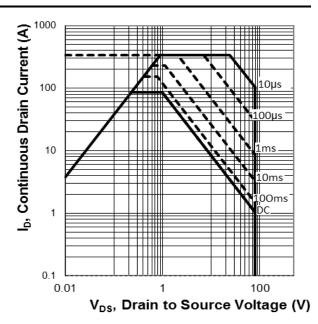


Figure 10: Maximum Safe Operation Area

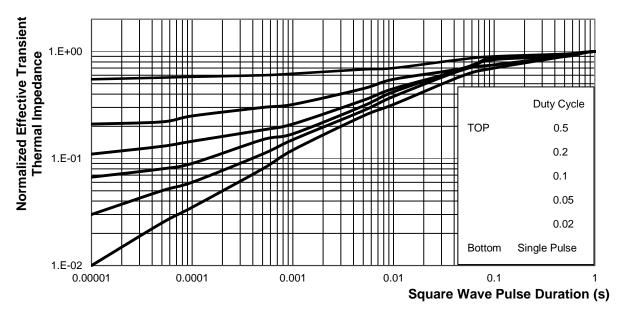


Figure 11: Normalized Thermal Transient Impedance, Junction-to-Case



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# 3. Marking information

**Top Marking Rule** 

PFC PRM 3R9N08N5 YYWW ABSH

PRM3R9N08N5 = Product Type Marking Code

YYWW = Date Code

YY = Last two digits of year

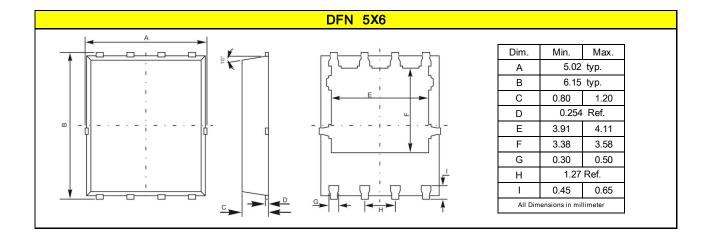
WW = Week code

ABS = Assembly code

H = Halogen Free (N/A = common molding compound)

# 4. Package information

Package Outline Dimensions millimeters





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## 5. Ordering information

Part Number	Package	Delivery mode
PRM3R9N08N5	DFN 5X6	5000 pcs / 13" diameter reel

### Mechanical

Molder Plastic: UL Flammability Classification Rating 94V-0
 Device Weight: 0.003 ounces (0.093grams) – DFN 5x6

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